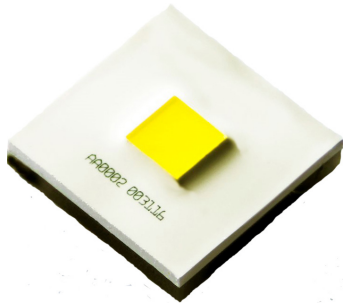


# XLamp® XP-P LEDs



## PRODUCT DESCRIPTION

XLamp® XP-P LEDs deliver breakthrough levels of intensity and optical control in a familiar XP footprint. With up to 700 lm available at maximum current from a very small LES, the XP-P enables tighter beam angles and much longer throw distances than any previous XLamp LED. XP-P LEDs are built to last in extreme applications, with high operating temperature limits and excellent sulfur resistance.

XP-P LEDs are optimized for lighting applications that require extreme levels of intensity, including aftermarket automotive, professional portable, architectural and entertainment.

## FEATURES

- ANSI-compatible chromaticity bins
- Maximum drive current: 3000 mA
- Low thermal resistance: 2.3 °C/W
- Wide viewing angle: 115°
- Unlimited floor life at ≤ 30 °C/85% RH
- Reflow solderable - JEDEC J-STD-020C
- Electrically neutral thermal path
- RoHS and REACH compliant
- UL® recognized component (E349212)

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Cree LED / 4400 Silicon Drive / Durham, NC 27703 USA / +1.919.313.5330 / [www.cree-led.com](http://www.cree-led.com)

## CHARACTERISTICS

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance*	°C/W		2.3	
Viewing angle (FWHM)	degrees		115	
Temperature coefficient of voltage	mV/°C		-1.2	
ESD withstand voltage (HBM per Mil-Std-883D)	V			8000
DC forward current	mA			3000
Reverse voltage	V			5
Forward voltage (@ 1000 mA, 25 °C)	V		3.1	3.5
Forward voltage (@ 1500 mA, 25 °C)	V		3.25	
Forward voltage (@ 2000 mA, 25 °C)	V		3.37	
Forward voltage (@ 3000 mA, 25 °C)	V		3.58	
LED junction temperature	°C			150

### Note

\* Thermal resistance measurement was performed per the JEDEC JESD51-14 standard.

## FLUX CHARACTERISTICS (T<sub>J</sub> = 25 °C)

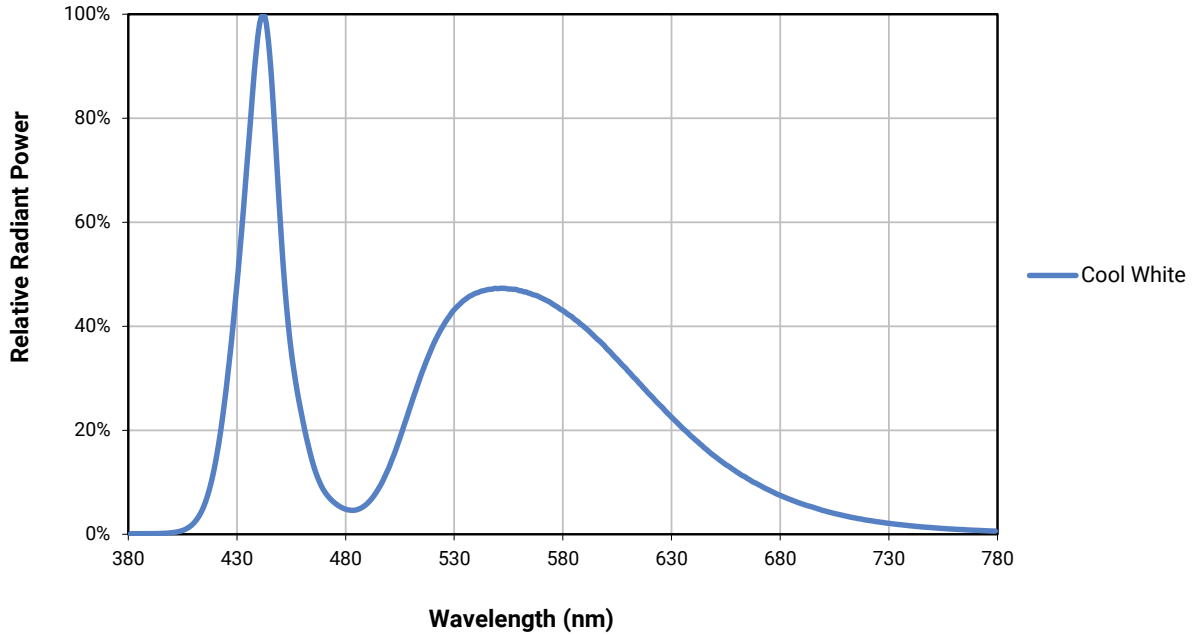
The following table provides order codes for XLamp XP-P LEDs. For a complete description of the order code nomenclature, please see the Bin and Order Code Formats section (page 11). For definitions of the chromaticity kits, please see the Standard Chromaticity Kits section (page 11).

Chromaticity		Minimum Luminous Flux (lm) @ 1000 mA		Order Codes
Kit	CCT	Code	Flux (lm)	65 CRI Typical
DT	7000 K	U5	360	XPPAWT-H0-0000-0000U50DT
E1	6500 K	U5	360	XPPAWT-H0-0000-0000U50E1
CV	6000 K	U5	360	XPPAWT-H0-0000-0000U50CV
DV	6000 K	U5	360	XPPAWT-H0-0000-0000U50DV
CW	5700 K	U5	360	XPPAWT-H0-0000-0000U50CW
E2	5700 K	U5	360	XPPAWT-H0-0000-0000U50E2
E3	5000 K	U5	360	XPPAWT-H0-0000-0000U50E3

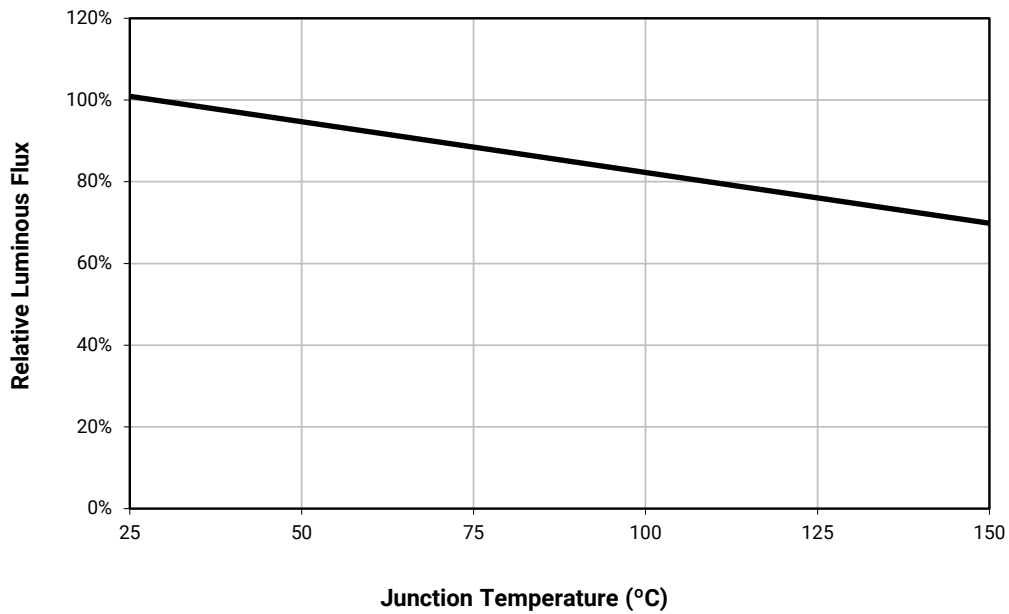
### Notes

- Cree LED maintains a tolerance of  $\pm 7\%$  on flux and power measurements,  $\pm 0.005$  on chromaticity (CCx, CCy) measurements and a tolerance of  $\pm 2$  on CRI measurements. See the Measurements section (page 13).
- Lamp XP-P LED order codes specify only a minimum flux bin and not a maximum. Cree LED may ship reels in flux bins higher than the minimum specified by the order code without advance notice. Shipments will always adhere to the chromaticity bin restrictions specified by the order code.

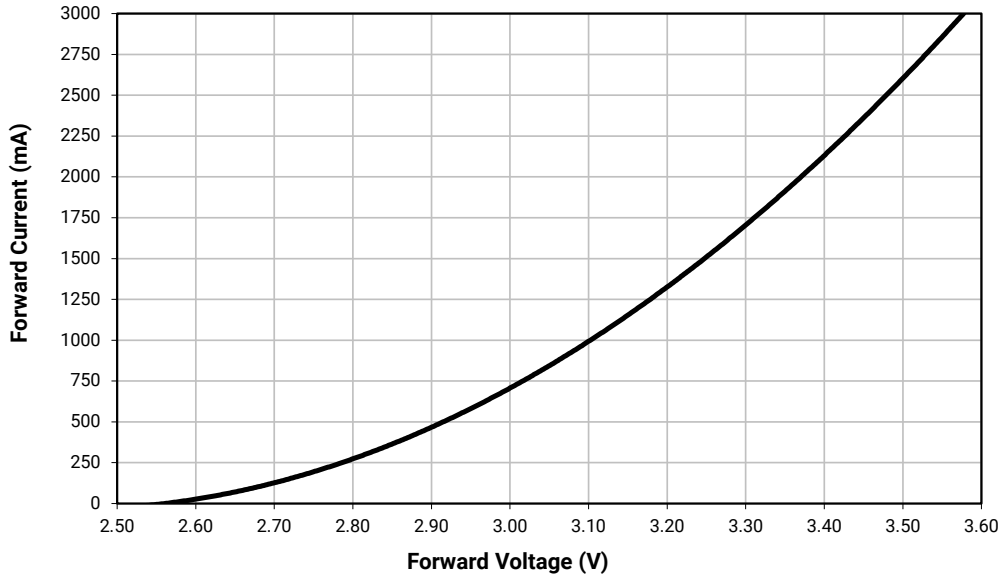
RELATIVE SPECTRAL POWER DISTRIBUTION



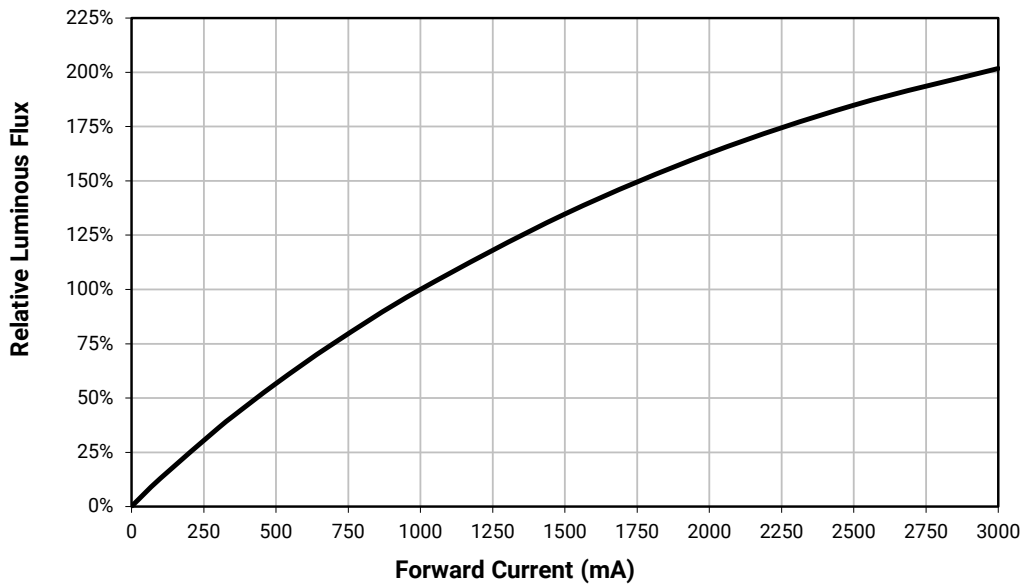
RELATIVE FLUX VS. JUNCTION TEMPERATURE ( $I_f = 1000 \text{ mA}$ )



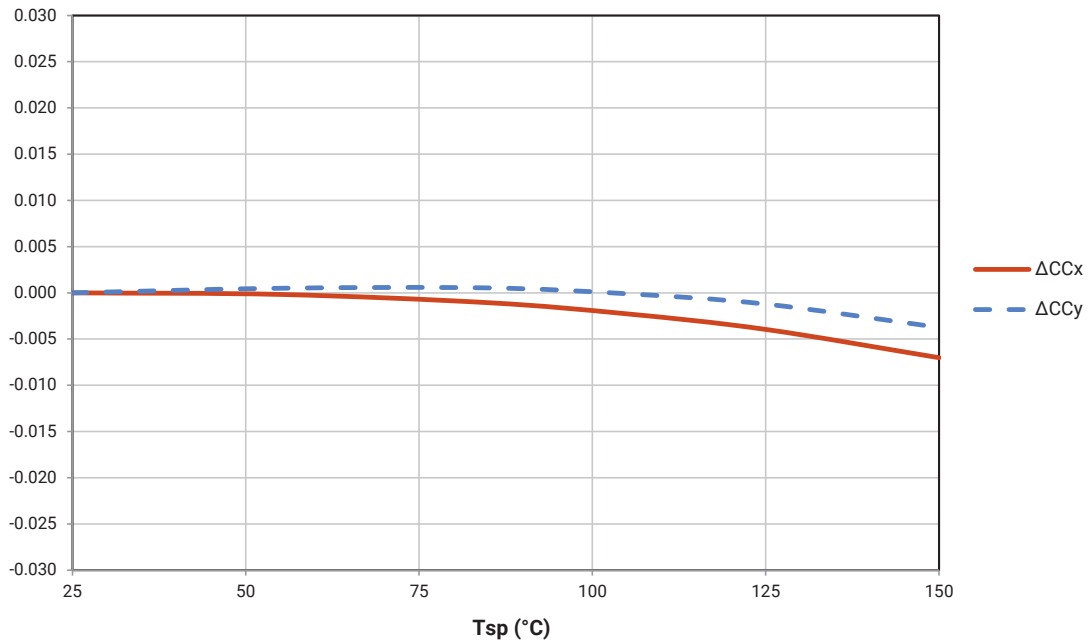
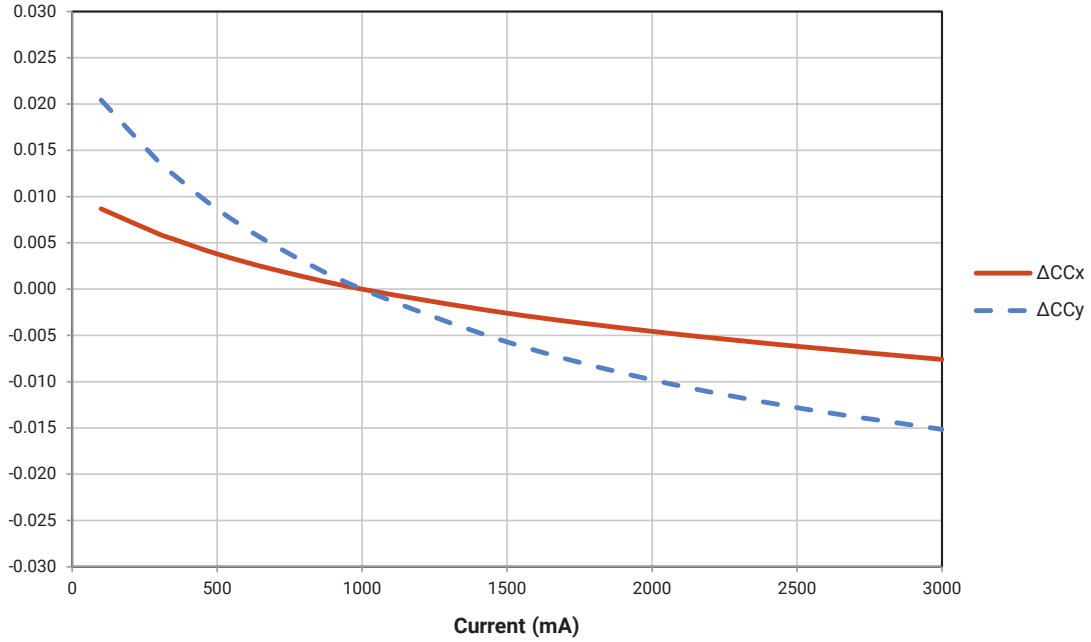
**ELECTRICAL CHARACTERISTICS ( $T_j = 25\text{ }^\circ\text{C}$ )**



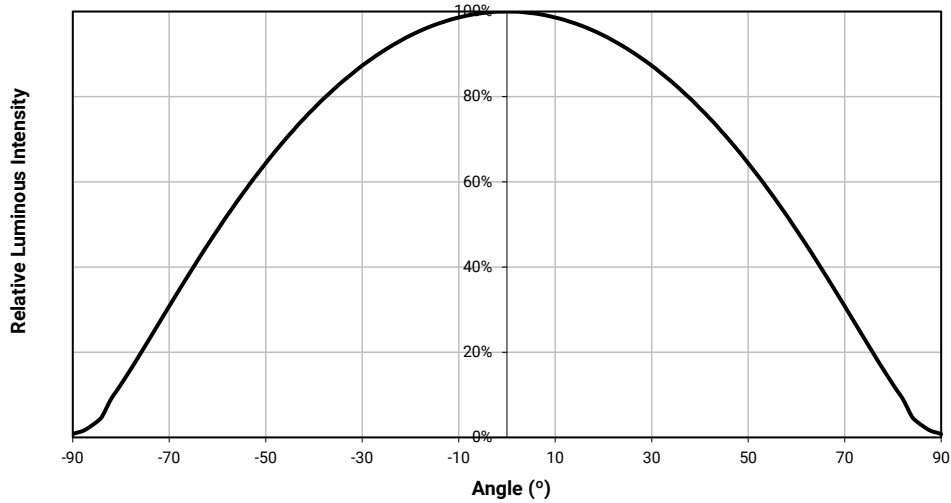
**RELATIVE FLUX VS. CURRENT ( $T_j = 25\text{ }^\circ\text{C}$ )**



RELATIVE CHROMATICITY VS CURRENT AND TEMPERATURE

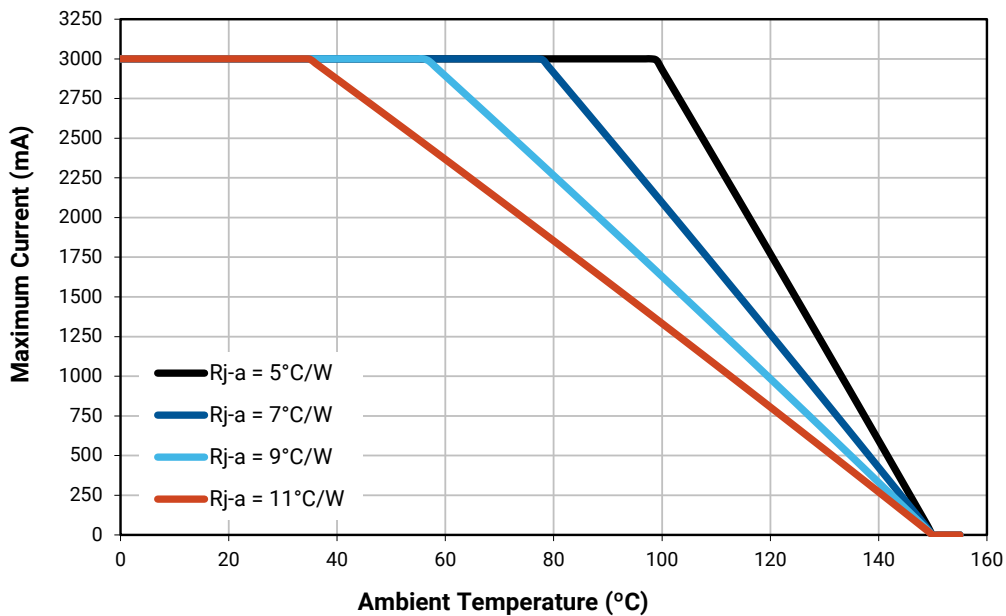


## TYPICAL SPATIAL DISTRIBUTION



## THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.



## PERFORMANCE GROUPS – LUMINOUS FLUX

XLamp XP-P LEDs are tested for luminous flux and placed into one of the following luminous-flux groups:

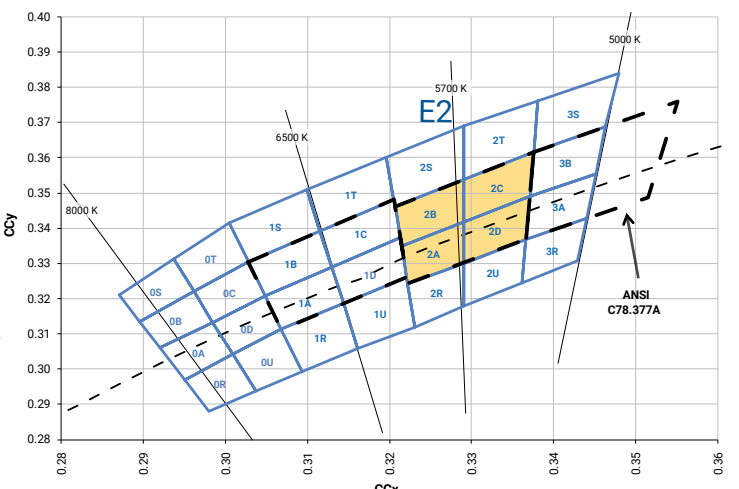
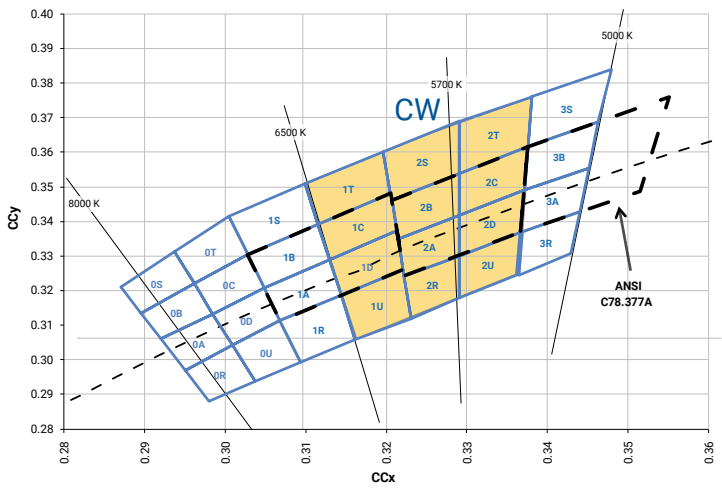
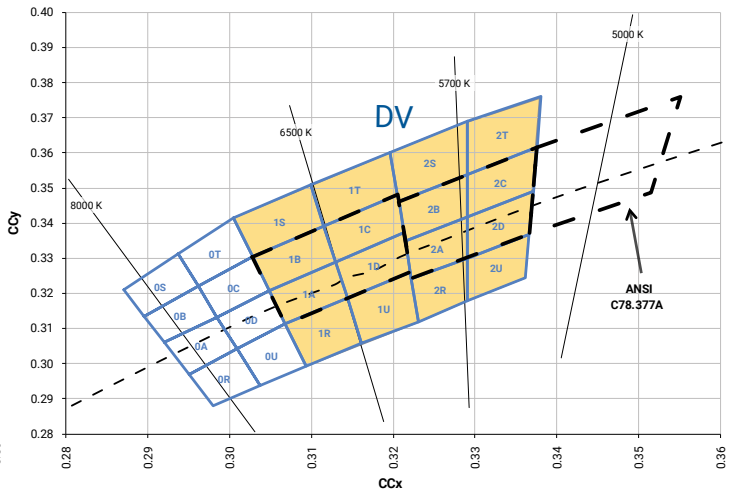
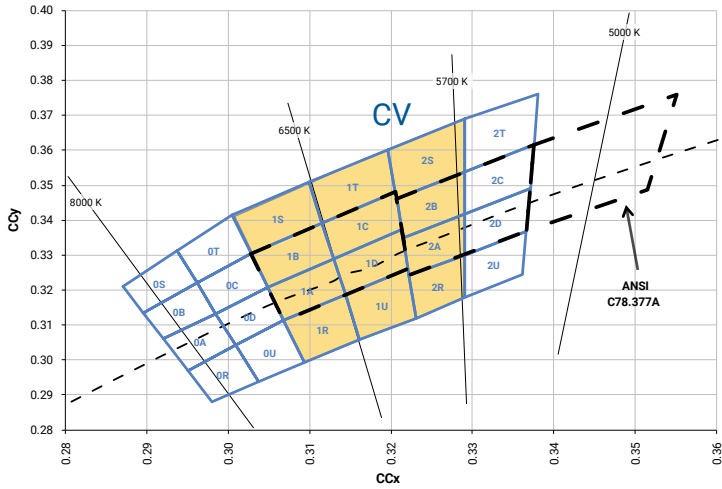
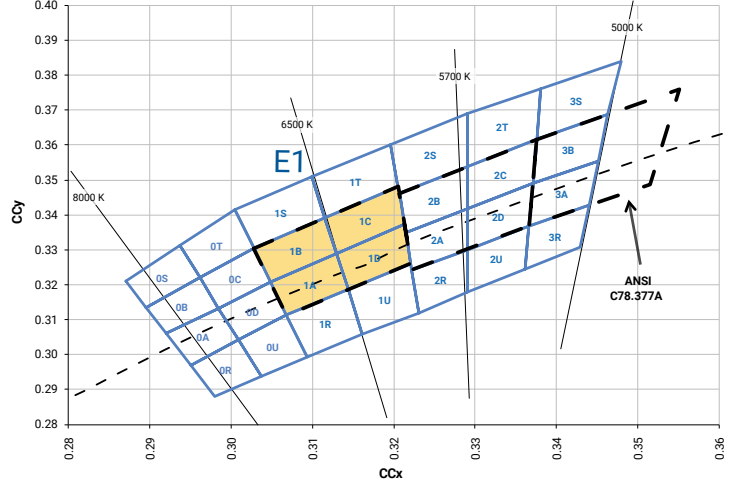
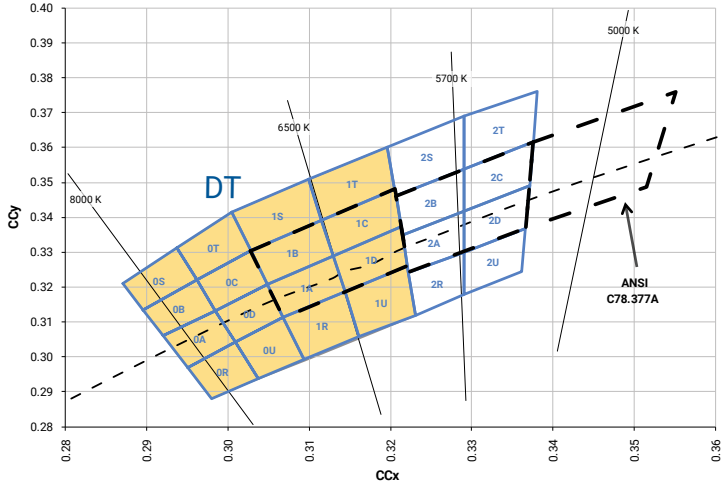
Group Code	Minimum Luminous Flux (lm) @ 1000 mA	Maximum Luminous Flux (lm) @ 1000 mA
U5	360	380
U6	380	400
V2	400	420

## PERFORMANCE GROUPS – CHROMATICITY

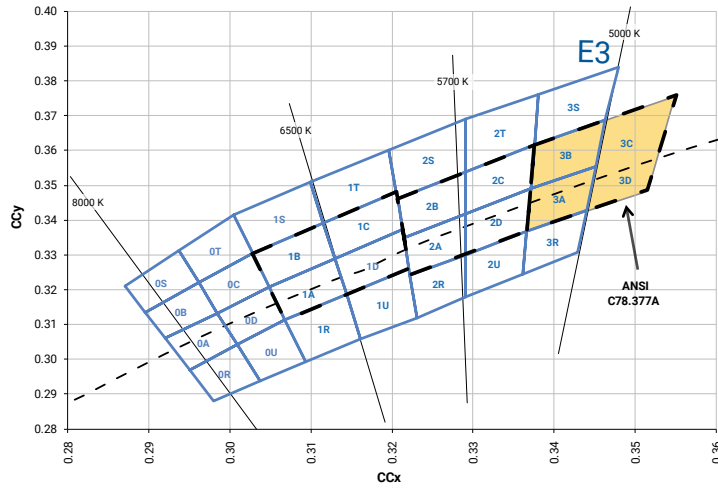
Region	x	y	Region	x	y	Region	x	y	Region	x	y
0A	0.2950	0.2970	0B	0.2920	0.3060	0C	0.2984	0.3133	0D	0.2984	0.3133
	0.2920	0.3060		0.2895	0.3135		0.2962	0.3220		0.3048	0.3207
	0.2984	0.3133		0.2962	0.3220		0.3028	0.3304		0.3068	0.3113
	0.3009	0.3042		0.2984	0.3133		0.3048	0.3207		0.3009	0.3042
0R	0.2980	0.2880	0S	0.2895	0.3135	0T	0.2962	0.3220	0U	0.3037	0.2937
	0.2950	0.2970		0.2870	0.3210		0.2937	0.3312		0.3009	0.3042
	0.3009	0.3042		0.2937	0.3312		0.3005	0.3415		0.3068	0.3113
	0.3037	0.2937		0.2962	0.3220		0.3028	0.3304		0.3093	0.2993
1A	0.3048	0.3207	1B	0.3028	0.3304	1C	0.3115	0.3391	1D	0.3130	0.3290
	0.3130	0.3290		0.3115	0.3391		0.3205	0.3481		0.3213	0.3373
	0.3144	0.3186		0.3130	0.3290		0.3213	0.3373		0.3221	0.3261
	0.3068	0.3113		0.3048	0.3207		0.3130	0.3290		0.3144	0.3186
1R	0.3068	0.3113	1S	0.3005	0.3415	1T	0.3099	0.3509	1U	0.3144	0.3186
	0.3144	0.3186		0.3099	0.3509		0.3196	0.3602		0.3221	0.3261
	0.3161	0.3059		0.3115	0.3391		0.3205	0.3481		0.3231	0.3120
	0.3093	0.2993		0.3028	0.3304		0.3115	0.3391		0.3161	0.3059
2A	0.3215	0.3350	2B	0.3207	0.3462	2C	0.3290	0.3538	2D	0.3290	0.3417
	0.3290	0.3417		0.3290	0.3538		0.3376	0.3616		0.3371	0.3490
	0.3290	0.3300		0.3290	0.3417		0.3371	0.3490		0.3366	0.3369
	0.3222	0.3243		0.3215	0.3350		0.3290	0.3417		0.3290	0.3300
2R	0.3222	0.3243	2S	0.3196	0.3602	2T	0.3290	0.3690	2U	0.3290	0.3300
	0.3290	0.3300		0.3290	0.3690		0.3381	0.3762		0.3366	0.3369
	0.3290	0.3180		0.3290	0.3538		0.3376	0.3616		0.3361	0.3245
	0.3231	0.3120		0.3207	0.3462		0.3290	0.3538		0.3290	0.3180
3A	0.3371	0.3490	3B	0.3376	0.3616	3R	0.3366	0.3369	3S	0.3381	0.3762
	0.3451	0.3554		0.3463	0.3687		0.3440	0.3428		0.3480	0.3840
	0.3440	0.3427		0.3451	0.3554		0.3429	0.3307		0.3463	0.3687
	0.3366	0.3369		0.3371	0.3490		0.3361	0.3245		0.3376	0.3616



STANDARD COOL WHITE KITS PLOTTED ON ANSI STANDARD CHROMATICITY REGIONS



STANDARD NEUTRAL WHITE KITS PLOTTED ON ANSI STANDARD CHROMATICITY REGIONS



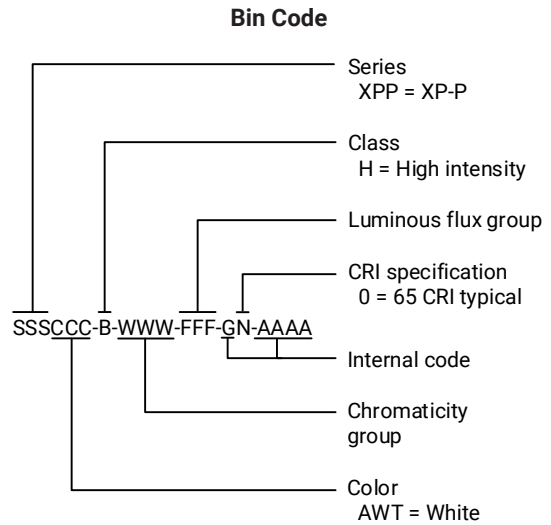
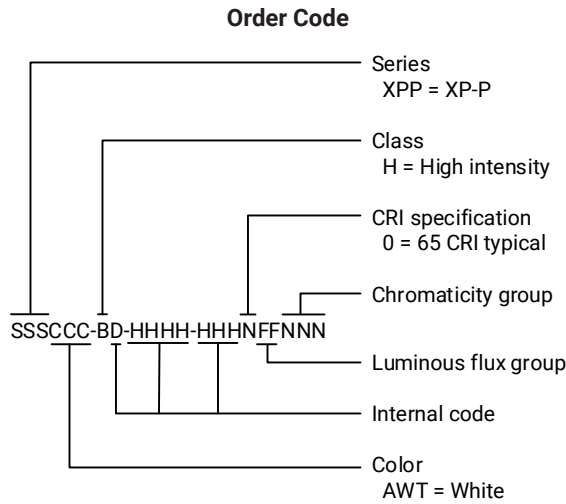
## STANDARD CHROMATICITY KITS

The following table provides the chromaticity bins associated with chromaticity kits.

Color	CCT	Kit	Chromaticity Bins
Cool White	7000 K	DT	0A, 0B, 0C, 0D, 0R, 0S, 0T, 0U, 1A, 1B, 1C, 1D, 1R, 1S, 1T, 1U
	6500 K	E1	1A, 1B, 1C, 1D
	6000 K	CV	1A, 1B, 1C, 1D, 1R, 1S, 1T, 1U, 2A, 2B, 2R, 2S
	6000 K	DV	1A, 1B, 1C, 1D, 1R, 1S, 1T, 1U, 2A, 2B, 2C, 2D, 2R, 2S, 2T, 2U
	5700 K	CW	1C, 1D, 1T, 1U, 2A, 2B, 2C, 2D, 2R, 2S, 2T, 2U
5700 K	E2	2A, 2B, 2C, 2D	
Neutral White	5000 K	E3	3A, 3B, 3C, 3D

## BIN AND ORDER CODE FORMATS

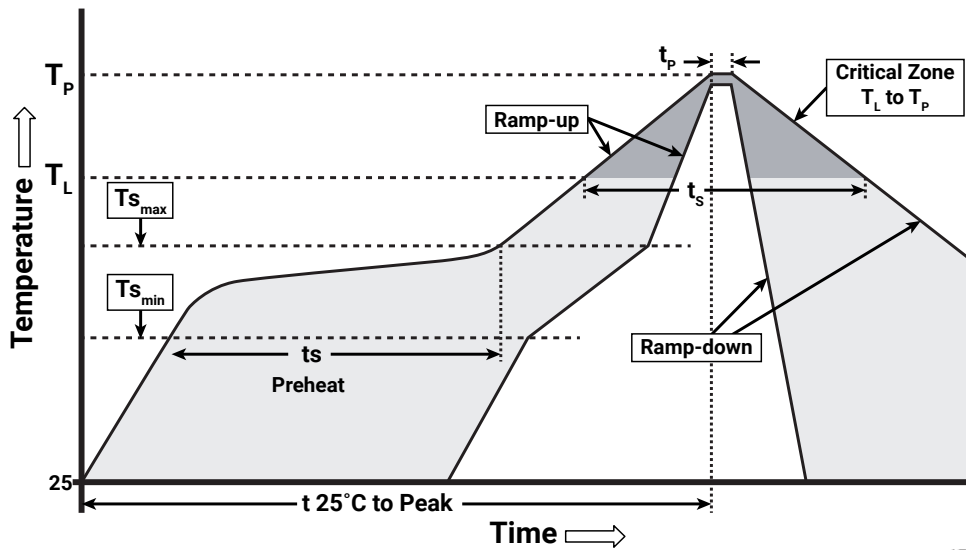
XP-P bin codes and order codes are configured in the following manner:



## REFLOW SOLDERING CHARACTERISTICS

In testing, Cree LED has found XLamp XP-P LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree LED recommends that users follow the recommended soldering profile provided by the manufacturer of the solder paste used, and therefore it is the lamp or luminaire manufacturer’s responsibility to determine applicable soldering requirements.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



IPC/JEDEC J-STD-020C

Profile Feature	Lead-Free Solder
Average Ramp-Up Rate ( $T_{s_{max}}$ to $T_p$ )	1.2 °C/second
Preheat: Temperature Min ( $T_{s_{min}}$ )	120 °C
Preheat: Temperature Max ( $T_{s_{max}}$ )	170 °C
Preheat: Time ( $t_{s_{min}}$ to $t_{s_{max}}$ )	65-150 seconds
Time Maintained Above: Temperature ( $T_L$ )	217 °C
Time Maintained Above: Time ( $t_L$ )	45-90 seconds
Peak/Classification Temperature ( $T_p$ )	235 - 245 °C
Time Within 5 °C of Actual Peak Temperature ( $t_p$ )	20-40 seconds
Ramp-Down Rate	1 - 6 °C/second
Time 25 °C to Peak Temperature	4 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.

## NOTES

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### Measurements

The luminous flux, radiant power, chromaticity, forward voltage and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree LED's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended or provided as specifications.

### Pre-Release Qualification Testing

Please read the [LED Reliability Overview](#) for details of the qualification process Cree LED applies to ensure long-term reliability for XLamp LEDs and details of Cree LED's pre-release qualification testing for XLamp LEDs.

### Lumen Maintenance

Cree LED now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public [LM-80 results document](#).

Please read the [Long-Term Lumen Maintenance application note](#) for more details on Cree LED's lumen maintenance testing and forecasting. Please read the [Thermal Management application note](#) for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature

### Moisture Sensitivity

Cree LED recommends keeping XLamp LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain XLamp LEDs do not need special storage for moisture sensitivity.

Once the MBP is opened, XLamp XP-P LEDs may be stored as MSL 1 per JEDEC J-STD-033, meaning they have unlimited floor life in conditions of  $\leq 30$  °C/85% relative humidity (RH). Regardless of the storage condition, Cree LED recommends sealing any unsoldered LEDs in the original MBP.

### RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree LED representative or from the [Product Ecology](#) section of the Cree LED website.

### REACH Compliance

REACH substances of very high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree LED representative to insure you get the most up-to-date REACH SVHC Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

## NOTES - CONTINUED

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### **UL® Recognized Component**

This product meets the requirements to be considered a UL Recognized Component with Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/UL 8750.

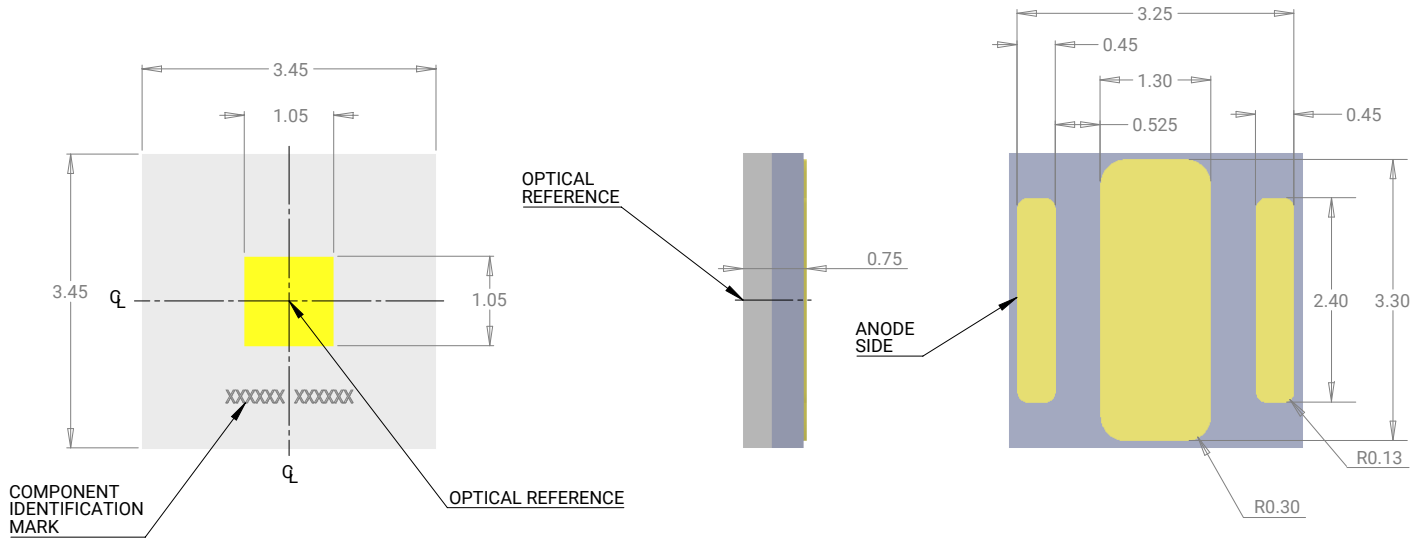
### **Vision Advisory**

WARNING: Do not look at an exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the [LED Eye Safety application note](#).

**MECHANICAL DIMENSIONS (T<sub>A</sub> = 25 °C)**

Thermal vias, if present, are not shown on these drawings.

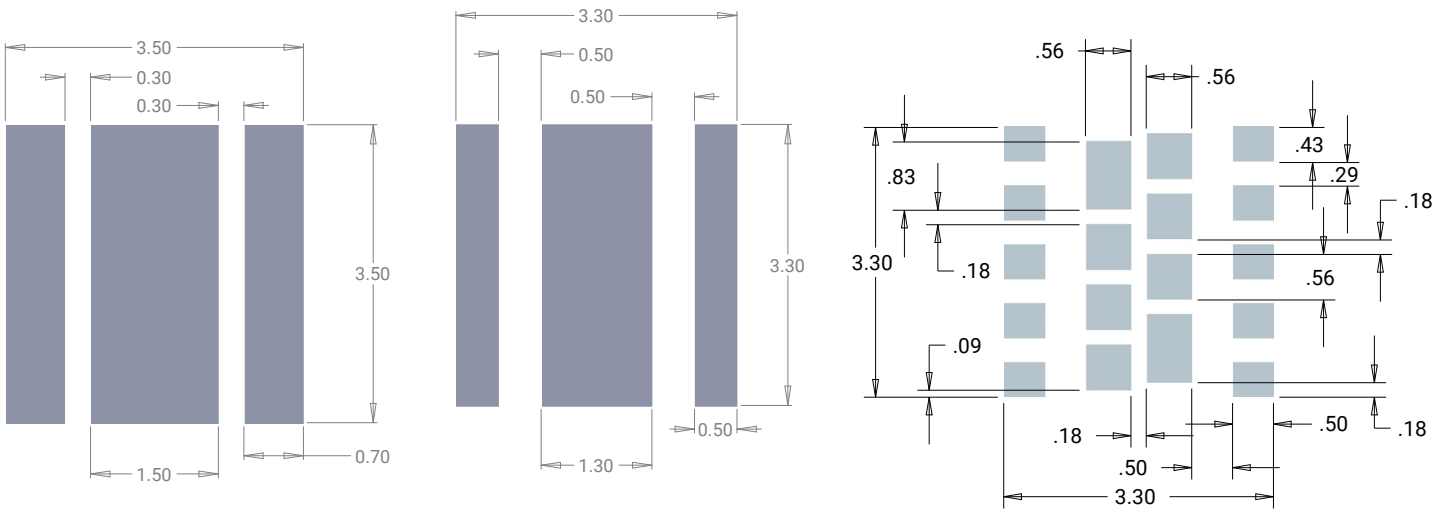
All dimensions are ±.1 mm unless otherwise indicated.



Top View

Side View

Bottom View



Recommended Copper Layout

Recommended Solder Pad  
(Solder Resist Pattern)

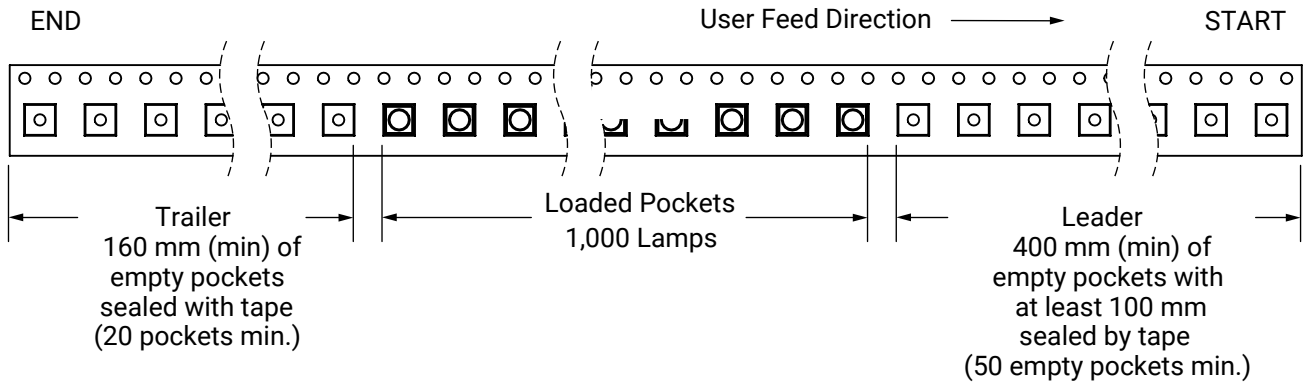
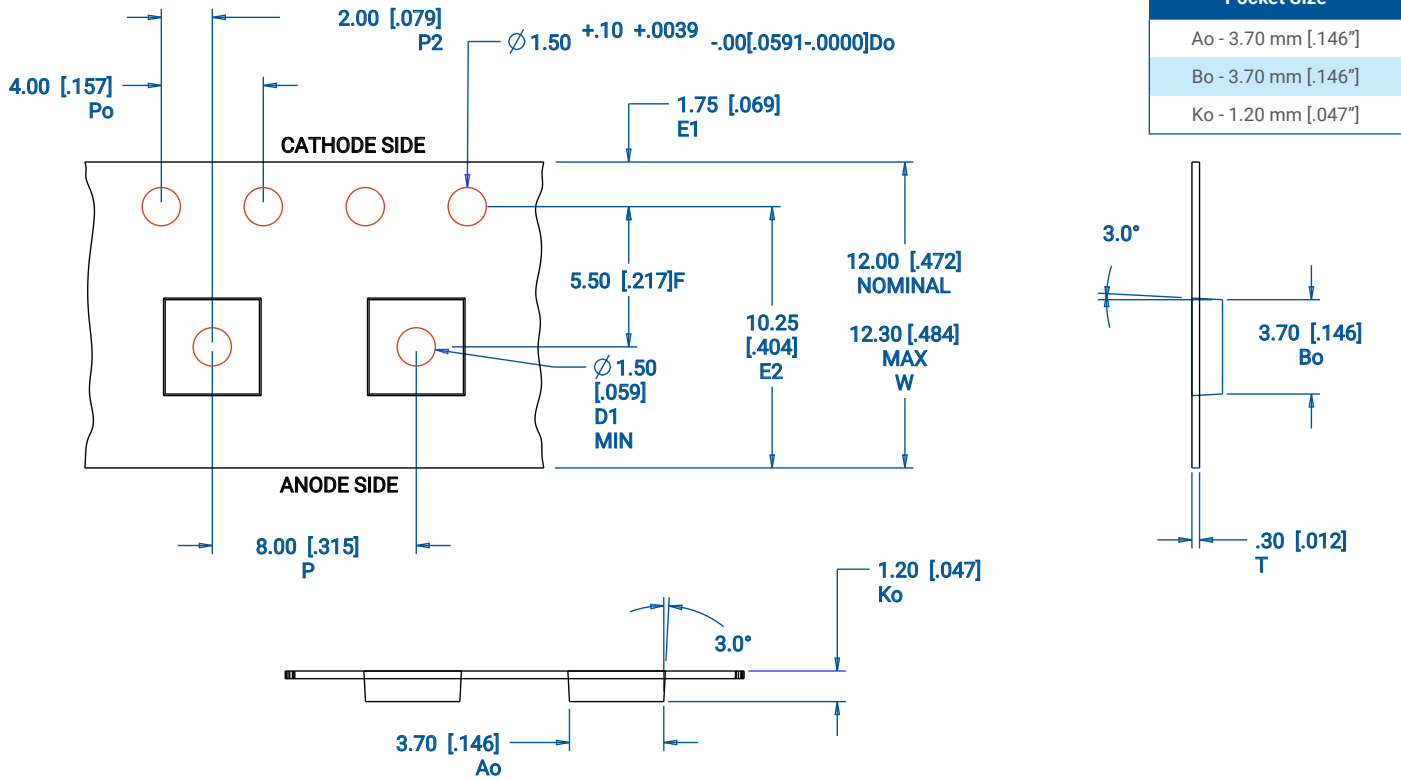
Recommended Stencil Openings\*

Notes:

- Cree LED recommends using thermal pad kickouts to maximize component thermal performance.
- Cree LED recommends using white solder mask material to minimize system optical loss.
- \* This stencil has been tested and optimized for the avoidance of voiding when using ALPHA® LUMET® P30 Maxrel solder paste. For other solder pastes, a "window pane" design for the thermal pad stencil may result in a lower voiding percentage. Contact your local Cree LED Field Applications Engineer for consultation regarding your specific application.

**TAPE AND REEL**

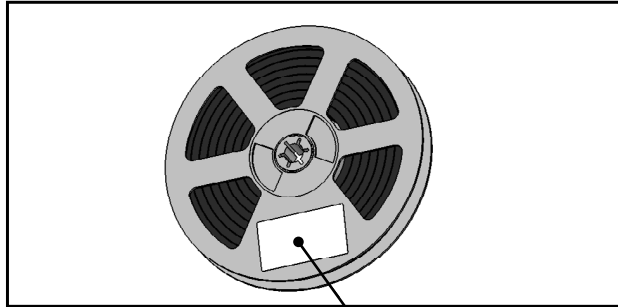
All Cree LED carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.





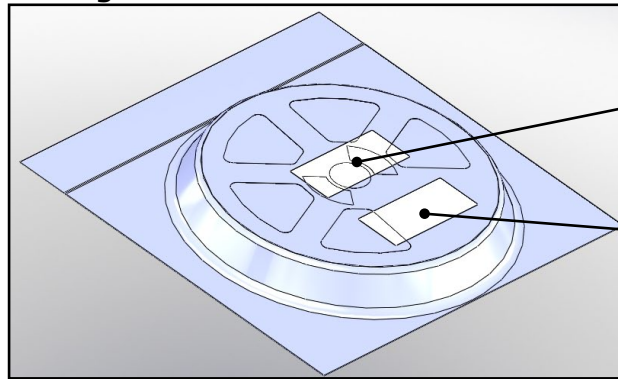
PACKAGING

Unpackaged Reel



Label with Cree Bin Code,  
Quantity, Reel ID

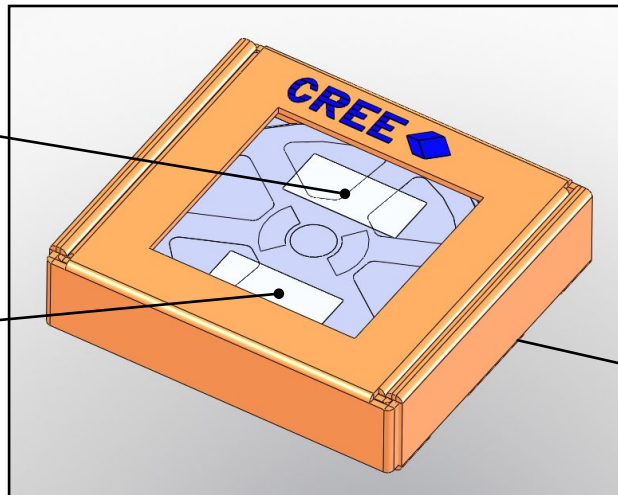
Packaged Reel



Label with Cree Order Code,  
Quantity, Reel ID, PO #

Label with Cree Bin Code,  
Quantity, Reel ID

Boxed Reel



Label with Cree Order Code,  
Quantity, Reel ID, PO #

Label with Cree Bin Code,  
Quantity, Reel ID

Patent Label  
(on bottom of box)

## X-ON Electronics

Largest Supplier of Electrical and Electronic Components

*Click to view similar products for [High Power LEDs - White category:](#)*

*Click to view products by [Cree manufacturer:](#)*

Other Similar products are found below :

[LTW-K140SZR40](#) [B42180-08](#) [STW8Q2PA-R5-HA](#) [LTPL-P00DWS57](#) [LTW-K140SZR30](#) [LZP-D0WW00-0000](#) [SZ5-M1-WW-C8-V1/V3-FA](#) [LTW-K140SZR57](#) [LTW-K140SZR27](#) [BXRE-50C2001-C-74](#) [MP-5050-8100-27-80](#) [MP-5050-6100-65-80](#) [MP-5050-6100-50-80](#) [MP-5050-6100-40-80](#) [MP-5050-6100-30-80](#) [KW DPLS32.SB-6H6J-E5P7-EG-Z264](#) [L1V1-507003V500000](#) [KW DMLS33.SG-Z6M7-EBVFFCBB46-8E8G-700-S](#) [GW PSLT33.PM-LYL3-XX56-1-G3](#) [ASMT-MW05-NMNS1](#) [KW DPLS33.KD-HIJG-D30D144-HN-22C2-120-S](#) [KW DDLM31.EH-5J6K-A737-W4A4-140-R18](#) [GW JTLRS1.CM-K1LW-XX57-1-100-Q-R33](#) [KW DDLM31.EH-5J6K-A636-W4A4-140-R18](#) [KW DDLM31.EH-5J6K-A131-W4A4-140-R18](#) [GW PSLT33.PM-LYL3-XX57-1-G3](#) [SML-LXL8047MWCTR/3](#) [L2C5-40HG1203E0900](#) [JB3030AWT-P-U27EA0000-N0000001](#) [JK3030AWT-P-U30EA0000-N0000001](#) [JK3030AWT-P-B40EB0000-N0000001](#) [JK3030AWT-P-H30EB0000-N0000001](#) [JK3030AWT-P-H40EB0000-N0000001](#) [JK3030AWT-P-U27EB0000-N0000001](#) [JK3030AWT-P-U30EB0000-N0000001](#) [XPGBWT-HE-0000-00JE5](#) [GW JCLPS2.EM-H3H8-A131-1-65-2-R33](#) [GW PUSTA1.PM-PAPC-XX53-1-1050-R18](#) [GW CSSRM2.PM-N3N5-XX53-1](#) [GW P9LMS1.EM-NRNU-30S7-0-200-R18](#) [GW PSLPS1.EC-KSKU-5R8T-1](#) [LTPL-M03614ZS50-F1](#) [LTW-2835SZK65](#) [LTW-3030AQL40](#) [LTW-3030AZL40-EU](#) [LTW-3030BSL42](#) [LTW-3030DZL30](#) [LTW-3030SZK40](#) [LTW-3030SZK65](#) [LTW-5630AQL27](#)